

IAP20 Rec'd PCT/PTO 29 MAR 2006

**APPLICATION DATA SHEET****Application Information**

Application number::

Filing Date::

Application Type::

Regular

Subject Matter::

Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?::

None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?::

No

Number of copies of CRF::

Title ::

METHOD FOR PREPARING CONDUCTIVE  
PASTE FOR INNER ELECTRODE OF MULTI-  
LAYERED CERAMIC ELECTRONIC  
COMPONENT

Attorney Docket Number::

890050.538USPC

Request for Early Publication?::

No

Request for Non-Publication?::

No

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity?::

No

Petition included?::

No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?::

No

**First Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Shigeki
Middle Name::	
Family Name::	Satou
Name Suffix::	
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State or Province of Residence::	
Country of Residence::	Japan
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City of mailing address::	Tokyo
State or Province of mailing address::	
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	103-8272

**Second Applicant Information**

Applicant Authority Type::	Inventor
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**Correspondence Information**Correspondence Customer Number :: **00500****Representative Information**

Representative Customer Number::		<b>00500</b>
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**Domestic Priority Information**

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2004/014161	09/28/04

**Foreign Priority Information**

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2003-340400	09/30/03	Yes

**Assignee Information**

Assignee name::	TDK Corporation
Street of mailing address::	1-13-1, Nihonbashi, Chuo-ku
City of mailing address::	Tokyo
State or Province of mailing address::	
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Postal or Zip Code of mailing address::	103-8272

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